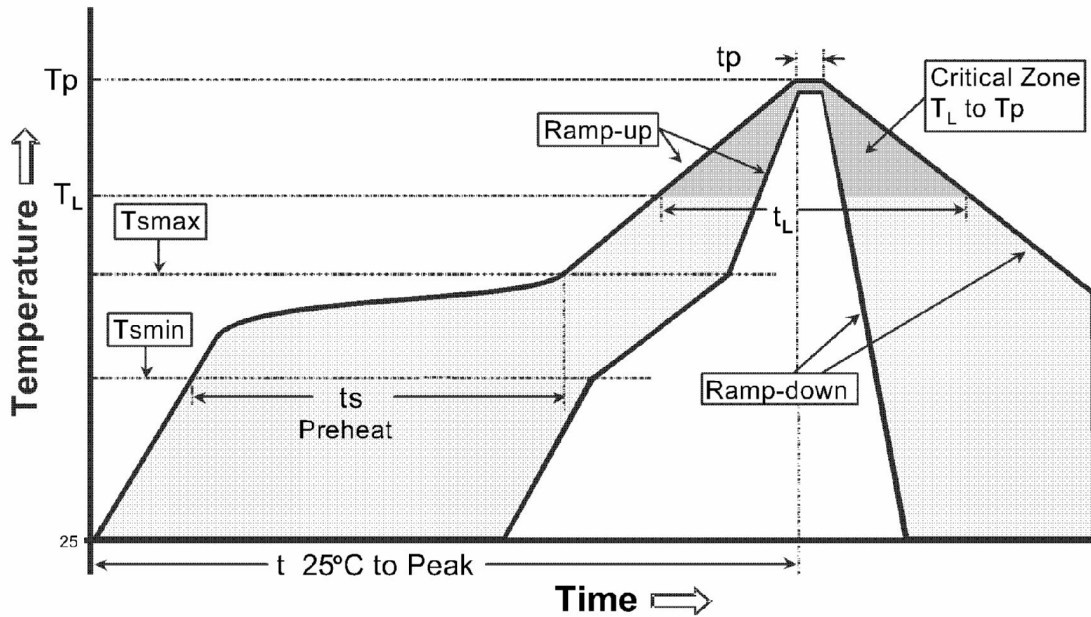


- **Reflow Solder Profile 1: 260+0/-5°C**



- Average ramp rate: 3°C per second maximum
- Preheat temperature (minimum): 150°C
- Preheat temperature (maximum): 200°C
- Preheat time: 60 to 180 seconds
- Ramp to Peak: 3°C per second maximum
- Time over liquidus (217°C): 60 to 150 seconds
- Peak temperature: 260+0/-5°C
- Time within -5°C of peak: 10 to 20 seconds
- Ramp- Cool Down: 6°C per second maximum
- Time 25°C to Peak: 8 minutes maximum